## Product Summary

| $\mathbf{B V}_{\text {DSS }}$ | $\mathbf{R}_{\mathbf{D S}(\mathbf{O N}) \text { Max }}$ | $\mathbf{I}_{\mathbf{D}}$ <br> $\mathbf{T}_{\mathbf{C}}=\mathbf{+ 2 5} \mathbf{C}$ |
| :---: | :---: | :---: |
|  | $15 \mathrm{~m} \Omega @ \mathrm{~V}_{\mathrm{GS}}=-10 \mathrm{~V}$ | -61 A |
|  | $23 \mathrm{~m} \Omega @ \mathrm{~V}_{\mathrm{GS}}=-4.5 \mathrm{~V}$ | -49 A |

## Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ( $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Reverse Polarity Protection
- BLDC Motor Control
- Power Management Functions


Top View


Bottom View

## Features and Benefits

- 100\% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMP4013SPSQ)


## Mechanical Data

- Case: PowerDI ${ }^{\circledR} 5060-8$
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish - 100\% Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.097 grams (Approximate)


Internal Schematic


Top View Pin Configuration

Ordering Information (Note 4)

| Part Number | Case | Packaging |
| :---: | :---: | :---: |
| DMP4013SPS-13 | PowerDI5060-8 | $2,500 /$ Tape \& Reel |

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) \& 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



[^0]PowerDI is a registered trademark of Diodes Incorporated.

DMP4013SPS
Maximum Ratings (@T $\mathrm{A}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic |  |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Drain-Source Voltage |  |  | $V_{\text {DSS }}$ | -40 | V |
| Gate-Source Voltage |  |  | $\mathrm{V}_{\text {GSS }}$ | $\pm 20$ | V |
| Continuous Drain Current VGS $=-10 \mathrm{~V}$ (Note 7) | Steady State | $\begin{aligned} & \hline \mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{C}}=+70^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | ID | $\begin{aligned} & \hline-61 \\ & -49 \\ & \hline \end{aligned}$ | A |
| Continuous Drain Current $\mathrm{V}_{\mathrm{GS}}=-10 \mathrm{~V}$ (Note 6) | Steady State | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C} \end{aligned}$ | ID | $\begin{gathered} \hline-11 \\ -9 \end{gathered}$ | A |
| Pulsed Drain Current (10 $\mu$ s Pulse, Duty Cycle = 1\%) |  |  | IDM | -244 | A |
| Maximum Body Diode Continuous Current (Note 7) |  |  | Is | -61 | A |
| Pulsed Source Current ( $10 \mu \mathrm{~s}$ Pulse, Duty Cycle = 1\%) |  |  | ISM | -244 | A |
| Avalanche Current (Note 8) L $=1 \mathrm{mH}$ |  |  | $\mathrm{I}_{\text {AS }}$ | -16 | A |
| Avalanche Energy (Note 8) $\mathrm{L}=1 \mathrm{mH}$ |  |  | $\mathrm{E}_{\text {AS }}$ | 176 | mJ |

## Thermal Characteristics (@ $\mathrm{T}_{\mathrm{A}}=+22^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Total Power Dissipation (Note 5) | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 1.6 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $\mathrm{R}_{\text {өJA }}$ | 96 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Total Power Dissipation (Note 6) | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 3.4 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | $\mathrm{R}_{\text {өJA }}$ | 44 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction to Case (Note 7) |  | $\mathrm{R}_{\text {өJC }}$ | 1.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range |  | $\mathrm{T}_{\mathrm{J}, \mathrm{TSTG}}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics (@T $\mathrm{A}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 9) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSS }}$ | -40 | - | - | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current | ldss | - | - | -1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DS}}=-40 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |
| Gate-Source Leakage | IGss | - | - | $\pm 100$ | nA | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 9) |  |  |  |  |  |  |
| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}(\mathrm{TH})$ | -1 | - | -3 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Static Drain-Source On-Resistance | R DS (ON) | - | 9.6 | 15 | $\mathrm{m} \Omega$ | $\mathrm{V}_{\mathrm{GS}}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-10 \mathrm{~A}$ |
|  |  | - | 13.4 | 23 |  | $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-8 \mathrm{~A}$ |
| Diode Forward Voltage | $\mathrm{V}_{S D}$ | - | -0.7 | -1.2 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{IS}=-1 \mathrm{~A}$ |
| DYNAMIC CHARACTERISTICS (Note 10) |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | - | 4004 | - | pF | $\begin{aligned} & V_{D S}=-20 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |
| Output Capacitance | $\mathrm{C}_{\text {oss }}$ | - | 309 | - |  |  |
| Reverse Transfer Capacitance | Crss | - | 229 | - |  |  |
| Gate Resistance | $\mathrm{R}_{\mathrm{g}}$ | - | 3.5 | - | $\Omega$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |
| Total Gate Charge (VGS $=-4.5 \mathrm{~V}$ ) | $\mathrm{Q}_{\mathrm{g}}$ | - | 31 | - | nC | $\begin{aligned} & V_{D S}=-20 V, \\ & I_{D}=-10 \mathrm{~A} \end{aligned}$ |
| Total Gate Charge (VGS $=-10 \mathrm{~V}$ ) | $\mathrm{Q}_{\mathrm{g}}$ | - | 67 | - |  |  |
| Gate-Source Charge | $\mathrm{Q}_{\mathrm{gs}}$ | - | 13.2 | - |  |  |
| Gate-Drain Charge | $\mathrm{Q}_{\mathrm{gd}}$ | - | 11 | - |  |  |
| Turn-On Delay Time | tD(ON) | - | 9.9 | - | ns | $\begin{aligned} & V_{G S}=-10 \mathrm{~V}, V_{D D}=-20 \mathrm{~V}, \\ & R_{G}=3 \Omega, I_{D}=-10 \mathrm{~A} \end{aligned}$ |
| Turn-On Rise Time | $\mathrm{t}_{\mathrm{R}}$ | - | 32 | - |  |  |
| Turn-Off Delay Time | tD(OFF) | - | 46 | - |  |  |
| Turn-Off Fall Time | $\mathrm{t}_{\mathrm{F}}$ | - | 53 | - |  |  |
| Reverse Recovery Time | trR | - | 19.5 | - | ns | $\mathrm{I}_{\mathrm{F}}=-10 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=-100 \mathrm{~A} / \mu \mathrm{s}$ |
| Reverse Recovery Charge | QRR | - | 11.6 | - | nC | $\mathrm{I}_{\mathrm{F}}=-10 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=-100 \mathrm{~A} / \mu \mathrm{s}$ |

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
6. Device mounted on FR-4 substrate PC board, 2 oz copper, with thermal bias to bottom layer 1 inch square copper plate.
7. Thermal resistance from junction to soldering point (on the exposed drain pad).
8. $I_{A S}$ and $E_{A S}$ ratings are based on low frequency and duty cycles to keep $T_{J}=+25^{\circ} \mathrm{C}$.
9. Short duration pulse test used to minimize self-heating effect.
10. Guaranteed by design. Not subject to product testing.

DMP4013SPS


Figure 1. Typical Output Characteristic


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage


Figure 5. Typical On-Resistance vs. Drain Current and Temperature


Figure 2. Typical Transfer Characteristic


Figure 4. Typical Transfer Characteristic


Figure 6. On-Resistance Variation with Temperature

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Figure 7. On-Resistance Variation with Temperature


Figure 9. Diode Forward Voltage vs. Current


Figure 11. Gate Charge


Figure 8. Gate Threshold Variation vs. Junction Temperature

$\mathrm{V}_{\text {DS }}$, DRAIN-SOURCE VOLTAGE (V)
Figure 10. Typical Junction Capacitance


Figure 12. SOA, Safe Operation Area

DMP4013SPS


Figure 13. Transient Thermal Resistance

DMP4013SPS

## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8


| PowerDI5060-8 |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A | 0.90 | 1.10 | 1.00 |
| A1 | 0.00 | 0.05 | - |
| b | 0.33 | 0.51 | 0.41 |
| b2 | 0.200 | 0.350 | 0.273 |
| b3 | 0.40 | 0.80 | 0.60 |
| c | 0.230 | 0.330 | 0.277 |
| D | 5.15 BSC |  |  |
| D1 | 4.70 | 5.10 | 4.90 |
| D2 | 3.70 | 4.10 | 3.90 |
| D3 | 3.90 | 4.30 | 4.10 |
| E | 6.15 BSC |  |  |
| E1 | 5.60 | 6.00 | 5.80 |
| E2 | 3.28 | 3.68 | 3.48 |
| E3 | 3.99 | 4.39 | 4.19 |
| e | 1.27 BSC |  |  |
| G | 0.51 | 0.71 | 0.61 |
| K | 0.51 | - | - |
| L | 0.51 | 0.71 | 0.61 |
| L1 | 0.100 | 0.200 | 0.175 |
| M | 3.235 | 4.035 | 3.635 |
| M1 | 1.00 | 1.40 | 1.21 |
| $\bigcirc$ | $10^{\circ}$ | $12^{\circ}$ | $11^{\circ}$ |
| 01 | $6^{\circ}$ | $8^{\circ}$ | $7^{\circ}$ |
| All Dimensions in mm |  |  |  |

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8


| Dimensions | Value (in mm) |
| :---: | :---: |
| $\mathbf{C}$ | 1.270 |
| $\mathbf{G}$ | 0.660 |
| $\mathbf{G 1}$ | 0.820 |
| $\mathbf{X}$ | 0.610 |
| $\mathbf{X 1}$ | 4.100 |
| $\mathbf{X 2}$ | 0.755 |
| $\mathbf{X 3}$ | 4.420 |
| $\mathbf{X 4}$ | 5.610 |
| $\mathbf{Y}$ | 1.270 |
| $\mathbf{Y 1}$ | 0.600 |
| $\mathbf{Y 2}$ | 1.020 |
| $\mathbf{Y 3}$ | 0.295 |
| $\mathbf{Y 4}$ | 1.825 |
| $\mathbf{Y 5}$ | 3.810 |
| $\mathbf{Y 6}$ | 0.180 |
| $\mathbf{Y 7}$ | 6.610 |

DMP4013SPS

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